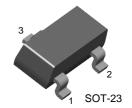


### BCX70G

### **General Purpose Transistor**



1. Base 2. Emitter 3. Collector

# **NPN Epitaxial Silicon Transistor**

## **Absolute Maximum Ratings** $T_a$ =25°C unless otherwise noted

Symbol	Parameter		∆ Value	Units
V <sub>CBO</sub>	Collector-Base Voltage		45	V
V <sub>CEO</sub>	Collector-Emitter Voltage	7. 10	45	V
V <sub>EBO</sub>	Emitter-Base Voltage	12 13	5	V
I <sub>C</sub>	Collector Current	× 23	200	mA
P <sub>C</sub>	Collector Power Dissipation	- O	350	mW
T <sub>STG</sub>	Storage Temperature		-55 ~ 150	°C

Refer to KST5088 for graphs

### Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
$BV_CEO$	Collector-Emitter Breakdown Voltage	I <sub>C</sub> =2mA, I <sub>B</sub> =0	45		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E=1\mu A, I_C=0$	5		V
I <sub>CES</sub>	Collector Cut-off Current	$V_{CE}$ =32V, $V_{BE}$ =0		20	nA
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB}$ =4V, $I_{C}$ =0		20	nA
h <sub>FE</sub>	DC Current Gain	$V_{CE}$ =5V, $I_{C}$ =2mA $V_{CE}$ =1V, $I_{C}$ =50mA	120 60	220	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =0.25mA I <sub>C</sub> =50mA, I <sub>B</sub> =1.25mA		0.35 0.55	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =0.25mA I <sub>C</sub> =50mA, I <sub>B</sub> =1.25mA	0.6 0.7	0.85 1.05	V
V <sub>BE</sub> (on)	Base-Emitter On Voltage	I <sub>C</sub> =2mA, V <sub>CE</sub> =5V	0.55	0.75	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> =5V, I <sub>C</sub> =10mA	125		MHz
f <sub>T</sub> C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=1MHz		4.5	pF
NF	Noise Figure	$I_C$ =0.2mA, $V_{CE}$ =5V f=1KHz, $R_S$ =2K $\Omega$		6	dB
t <sub>ON</sub>	Turn On Time	I <sub>C</sub> =10mA, I <sub>B1</sub> =1mA		150	
t <sub>OFF</sub>	Turn Off Time	$I_{B2}$ =1mA, $V_{BB}$ =3.6V $R_L$ =990 $\Omega$ $R_1$ = $R_2$ =5K $\Omega$		800	ns ns

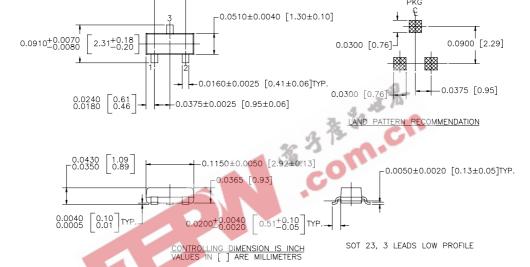




## **Package Dimensions**

## **SOT-23**

-0.0750±0.0050 [1.91±0.13]



- 1. STANDARD LEAD FINISH 150 MICROINCHES / 3.81 MICROMETERS MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
- 2. REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

Dimensions in Millimeters

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E <sup>2</sup> CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	$I^2C^{TM}$	$OCX^{TM}$	RapidConfigure™	UHC™
Across the board.	Around the world.™	OCXPro™	RapidConnect™	UltraFET <sup>®</sup>
The Power Franchise™		OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX™
Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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